

## NPN transistor/Schottky rectifier module

Rev. 02 — 31 August 2009

**Product data sheet** 

### 1. Product profile

### 1.1 General description

Combination of an NPN transistor with low  $V_{CEsat}$  and high current capability and a planar Schottky barrier rectifier with an integrated guard ring for stress protection in a SOT457 (SC-74) small plastic package. PNP complement: PMEM4020APD

### **1.2 Features**

- 600 mW total power dissipation
- High current capability up to 2 A
- Reduces printed-circuit board area required
- Reduces pick and place costs
- Small plastic SMD package
- Transistor
  - Low collector-emitter saturation voltage
- Diode
  - Ultra high-speed switching
  - Very low forward voltage
  - Guard ring protected

### **1.3 Applications**

- DC-to-DC converters
- Inductive load drivers
- General purpose load drivers
- Reverse polarity protection circuits
- MOSFET drivers

### 1.4 Quick reference data

### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
NPN trans	sistor					
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	40	V
I <sub>C</sub>	collector current (DC)	continuous; T <sub>s</sub> ≤ 55 °C	<u>[1]</u> _	-	2	А



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Table 1.	Quick reference data continued					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Schottky	barrier rectifier					
V <sub>R</sub>	continuous reverse voltage		-	-	40	V
l <sub>F</sub>	continuous forward current		-	-	1	А

[1] Soldering point of collector or cathode tab.

### 2. Pinning information

Table 2.	Discrete pinning		
Pin	Description	Simplified outline	Symbol
1	emitter		0
2	not connected		4 3
3	cathode		6
4	anode		5 1
5	base		sym041
6	collector		

### 3. Ordering information

#### Table 3.Ordering information

Type number	number Package		
	Name	Description	Version
PMEM4020AND	SC-74	plastic surface mounted package; 6 leads	SOT457

### 4. Marking

Table 4. Marking	
Type number	Marking code
PMEM4020AND	D2

### 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
NPN trans	istor				
V <sub>CBO</sub>	collector-base voltage	open emitter	-	40	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	40	V
$V_{\text{EBO}}$	emitter-base voltage	open collector	-	5	V

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Symbol	Parameter	Conditions	Min	Max	Unit
I <sub>C</sub>	collector current (DC)	continuous	<u>[1]</u> _	0.95	А
		continuous	[2] _	1.30	А
		continuous	[3]	1.65	А
		continuous; T <sub>s</sub> ≤ 55 °C	<u>[4]</u> _	2	А
I <sub>CM</sub>	peak collector current		-	3	А
I <sub>BM</sub>	peak base current		-	1	А
P <sub>tot</sub> total power dis	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	295	mW
		$T_{amb} \le 25 \ ^{\circ}C$	[2]	400	mW
		$T_{amb} \le 25 \ ^{\circ}C$	[3] _	500	mW
		T <sub>s</sub> ≤ 55 °C	[4]	1000	mW
Tj	junction temperature		-	150	°C
Schottky b	parrier rectifier				
V <sub>R</sub>	continuous reverse voltage		-	40	V
l <sub>F</sub>	continuous forward voltage		-	1	А
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 1ms;  \delta \le 0.5$	-	3.5	А
I <sub>FSM</sub>	non-repetitive peak forward current	t = 8 ms; square wave	-	10	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	295	mW
		$T_{amb} \le 25 \ ^{\circ}C$	[2] _	400	mW
		$T_{amb} \le 25 \ ^{\circ}C$	[3]	500	mW
		T <sub>s</sub> ≤ 55 °C	[4]	1000	mW
Tj	junction temperature		[2] _	150	°C
Combined	device				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[2] _	600	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		[2] -65	+150	°C

#### Table 5. Limiting values ... continued

[1] Mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, standard footprint.

[2] Device mounted on a printed-circuit board, single-sided copper, tin-plated, 1cm<sup>2</sup> mounting pad for both collector and cathode.

[3] Mounted on a ceramic printed-circuit board, single-sided copper, tin-plated, standard footprint.

[4] Soldering point of collector or cathode tab.

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### 6. Thermal characteristics

Table 6.	Table 6.         Thermal characteristics <sup>[1]</sup>					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Single d	evice					
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point	in free air	[2]	-	95	K/W
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[3] _	-	250	K/W
	junction to ambient		[4] _	-	315	K/W
		[5] _	-	425	K/W	
Combin	ed device					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[3]</u>	-	208	K/W

[1] For Schottky barrier rectifiers thermal run-away has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses. Nomograms for determining the reverse power losses  $P_R$  and  $I_{F(AV)}$  rating will be available on request.

[2] Soldering point of collector or cathode tab.

[3] Mounted on a ceramic printed-circuit board, single-sided copper, tin-plated, standard footprint.

[4] Device mounted on a printed-circuit board, single-sided copper, tin-plated, 1cm<sup>2</sup> mounting pad for both collector and cathode tab.

[5] Mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, standard footprint.

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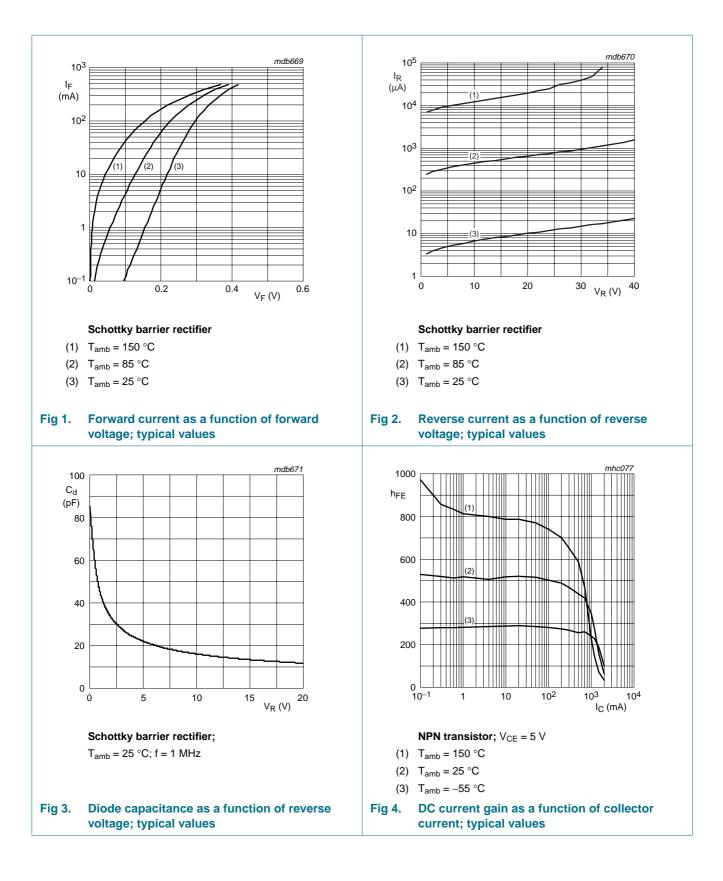
### 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
NPN transi	stor						
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = 40 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
	current	$\label{eq:VCB} \begin{array}{l} V_{CB} = 40 \; V; \; I_E = 0 \; A; \\ T_j = 150 \; ^\circ C \end{array}$		-	-	50	μΑ
I <sub>CEO</sub>	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A}$		-	-	100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$		-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$		300	-	-	
		$V_{CE} = 5 \text{ V}; I_{C} = 500 \text{ mA}$		300	-	900	
		$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ A}$		200	-	-	
		$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ A}$	<u>[1]</u>	75	-	-	
V <sub>CEsat</sub> collector-emitter saturation voltage		$I_{C} = 100 \text{ mA}; I_{B} = 1 \text{ mA}$		-	-	75	mV
	saturation voltage	$I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}$		-	-	100	mV
		$I_{C} = 1 \text{ A}; I_{B} = 100 \text{ mA}$		-	-	190	mV
	$I_{C} = 2 \text{ A}; I_{B} = 200 \text{ mA}$		-	-	400	mV	
R <sub>CEsat</sub>	equivalent on-resistance	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA	<u>[1]</u>	-	150	190	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA	<u>[1]</u>	-	-	1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 1 \text{ A}$	<u>[1]</u>	-	-	1.1	V
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 50 mA; f = 100 MHz		150	-	-	MHz
C <sub>c</sub>	collector capacitance	$V_{CB}$ = 10 V; I <sub>E</sub> = i <sub>e</sub> = 0 A; f = 1 MHz		-	-	10	pF
Schottky b	arrier rectifier						
V <sub>F</sub>	continuous forward	see Figure 1					
	voltage	$I_{\rm F} = 0.1  {\rm mA}$	<u>[1]</u>	-	95	130	mV
		$I_F = 1 \text{ mA}$	<u>[1]</u>	-	155	210	mV
		I <sub>F</sub> = 10 mA	<u>[1]</u>		220	270	mV
		I <sub>F</sub> = 100 mA	<u>[1]</u>		295	350	mV
		I <sub>F</sub> = 1000 mA	<u>[1]</u>	-	540	640	mV
I <sub>R</sub>	reverse current	see Figure 2					
		V <sub>R</sub> = 10 V	<u>[1]</u>		7	20	μA
		V <sub>R</sub> = 40 V	<u>[1]</u>	-	30	100	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; see Figure 3		-	43	48	pF

[1] Pulse test:  $t_p \leq 300 \ \mu s; \ \delta \leq 0.02$ 

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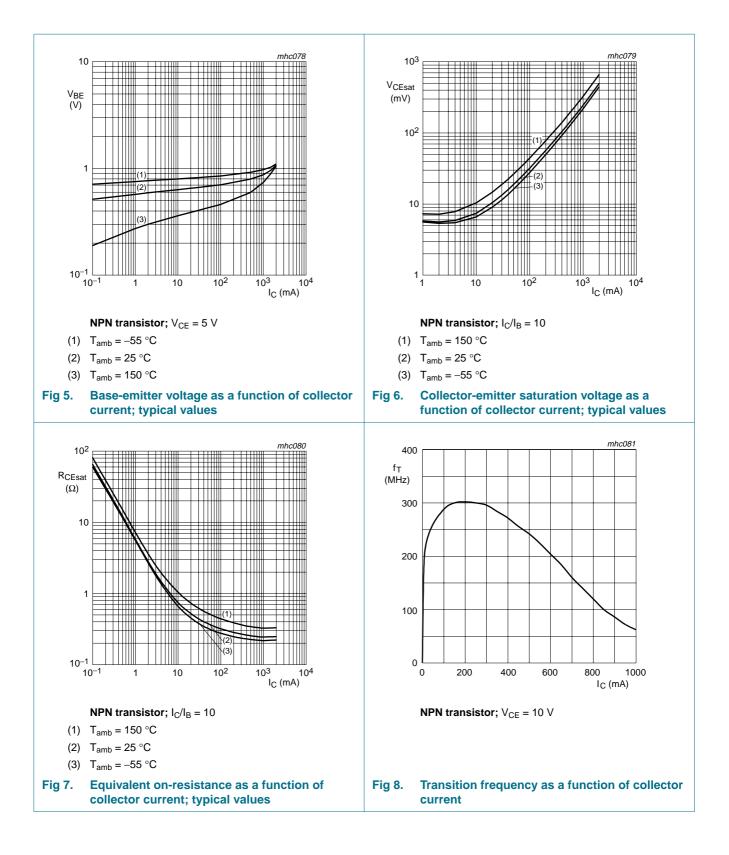


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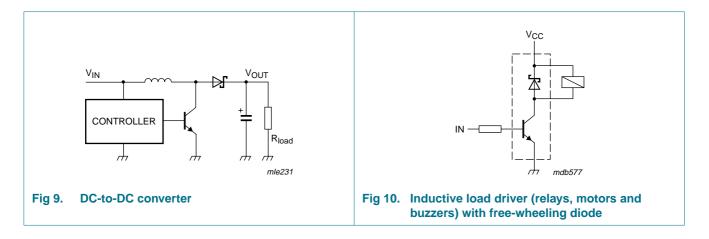
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### 8. Application information



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### 9. Package outline

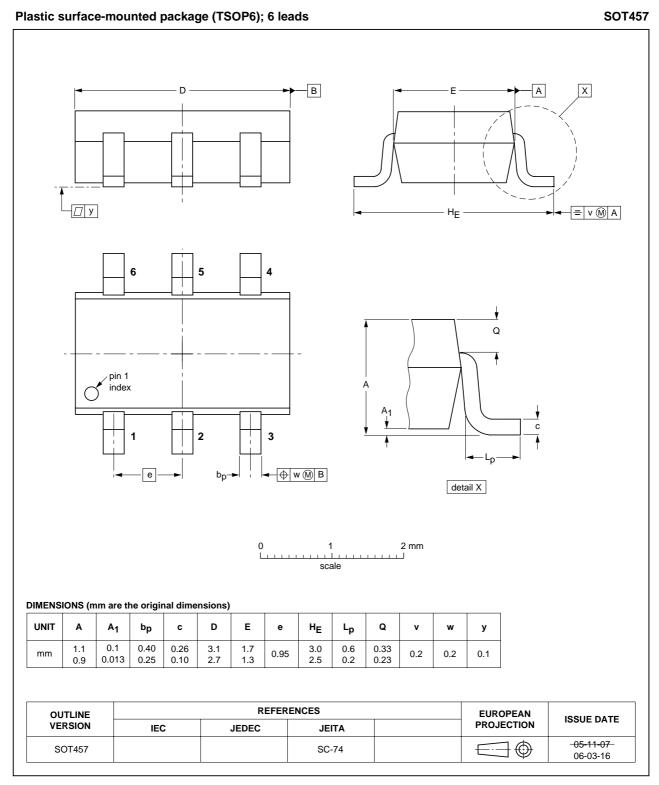


Fig 11. Package outline SOT457 (SC-74)

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### **10. Packing information**

#### Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity		
			3000	10000	
PMEM4020AND	SOT457	4 mm pitch, 8 mm tape and reel; T1	-115	-135	
		4 mm pitch, 8 mm tape and reel; T2	-125	-165	

[1] For further information and the availability of packing methods, see <u>Section 13</u>.

### NPN transistor/Schottky rectifier module

### **11. Revision history**

Table 9. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEM4020AND_2	20090831	Product data sheet	-	PMEM4020AND_1
Modifications:		t was changed to reflect egal definitions and disc		e NXP Semiconductors, ere made to the technical
	Table 2 "Discret	ete pinning": amended		
	<ul> <li>Figure 11 "Pac</li> </ul>	kage outline SOT457 (Se	C-74)": updated	
PMEM4020AND_1	20041004	Product data sheet	-	-

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### **12. Legal information**

### 12.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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